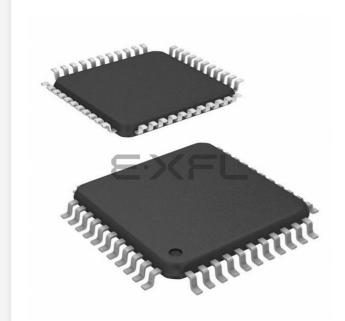
Altera - EPM7032STC44-7 Datasheet





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Understanding <u>Embedded - CPLDs (Complex</u> <u>Programmable Logic Devices)</u>

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixedfunction ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

| Product Status | Obsolete |
|---------------------------------|---|
| Programmable Type | In System Programmable |
| Delay Time tpd(1) Max | 7.5 ns |
| Voltage Supply - Internal | 4.75V ~ 5.25V |
| Number of Logic Elements/Blocks | 2 |
| Number of Macrocells | 32 |
| Number of Gates | 600 |
| Number of I/O | 36 |
| Operating Temperature | 0°C ~ 70°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 44-TQFP |
| Supplier Device Package | 44-TQFP (10x10) |
| Purchase URL | https://www.e-xfl.com/pro/item?MUrl=&PartUrl=epm7032stc44-7 |
| | |

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

| | Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, and VeriBest Programming support Altera's Master Programming Unit (MPU) and programming hardware from third-party manufacturers program all MAX 7000 devices The BitBlasterTM serial download cable, ByteBlasterMVTM parallel port download cable, and MasterBlasterTM serial/universal serial bus (USB) download cable program MAX 7000S devices |
|------------------------|---|
| General Description | The MAX 7000 family of high-density, high-performance PLDs is based on Altera's second-generation MAX architecture. Fabricated with advanced CMOS technology, the EEPROM-based MAX 7000 family provides 600 to 5,000 usable gates, ISP, pin-to-pin delays as fast as 5 ns, and counter speeds of up to 175.4 MHz. MAX 7000S devices in the -5, -6, -7, and -10 speed grades as well as MAX 7000 and MAX 7000E devices in -5, -6, -7, -10P, and -12P speed grades comply with the PCI Special Interest Group (PCI SIG) <i>PCI Local Bus Specification, Revision 2.2.</i> See Table 3 for available speed grades. |

| Device | | | | | Speed | Grade | | | | |
|----------|--------------|--------------|--------------|--------------|---|-------|--------------|--------------|----------------------|--------------|
| | -5 | -6 | -7 | -10P | -10 | -12P | -12 | -15 | -15T | -20 |
| EPM7032 | | > | ~ | | > | | > | ~ | | |
| EPM7032S | \checkmark | \checkmark | ~ | | \checkmark | | | | | |
| EPM7064 | | > | ~ | | > | | > | ~ | | |
| EPM7064S | \checkmark | \checkmark | ~ | | Image: A start of the start of | | | | | |
| EPM7096 | | | \checkmark | | \checkmark | | > | \checkmark | | |
| EPM7128E | | | ~ | \checkmark | Image: A set of the set of the | | > | ~ | | ~ |
| EPM7128S | | \checkmark | ~ | | Image: A set of the set of the | | | ~ | | |
| EPM7160E | | | | ~ | ~ | | \checkmark | ~ | | \checkmark |
| EPM7160S | | \checkmark | ~ | | Image: A set of the set of the | | | ~ | | |
| EPM7192E | | | | | | ~ | > | ~ | | > |
| EPM7192S | | | ~ | 1 | ~ | Ī | | ~ | | |
| EPM7256E | | | | | | ~ | > | ~ | | > |
| EPM7256S | | | \checkmark | | \checkmark | | | \checkmark | | |

The MAX 7000 architecture includes four dedicated inputs that can be used as general-purpose inputs or as high-speed, global control signals (clock, clear, and two output enable signals) for each macrocell and I/O pin. Figure 1 shows the architecture of EPM7032, EPM7064, and EPM7096 devices.

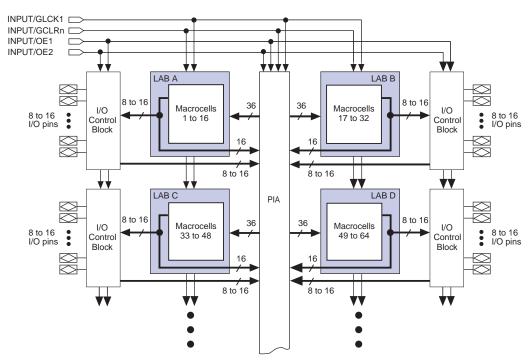


Figure 1. EPM7032, EPM7064 & EPM7096 Device Block Diagram

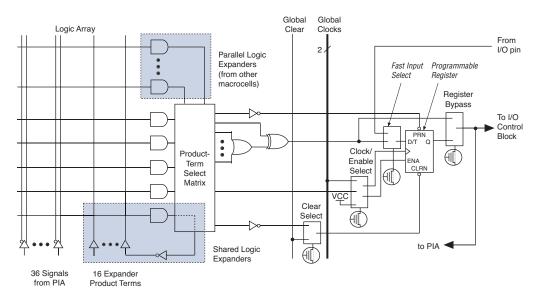
Each LAB is fed by the following signals:

- **3**6 signals from the PIA that are used for general logic inputs
- Global controls that are used for secondary register functions
- Direct input paths from I/O pins to the registers that are used for fast setup times for MAX 7000E and MAX 7000S devices

Macrocells

The MAX 7000 macrocell can be individually configured for either sequential or combinatorial logic operation. The macrocell consists of three functional blocks: the logic array, the product-term select matrix, and the programmable register. The macrocell of EPM7032, EPM7064, and EPM7096 devices is shown in Figure 3.

Figure 3. EPM7032, EPM7064 & EPM7096 Device Macrocell



Each programmable register can be clocked in three different modes:

- By a global clock signal. This mode achieves the fastest clock-tooutput performance.
- By a global clock signal and enabled by an active-high clock enable. This mode provides an enable on each flipflop while still achieving the fast clock-to-output performance of the global clock.
- By an array clock implemented with a product term. In this mode, the flipflop can be clocked by signals from buried macrocells or I/O pins.

In EPM7032, EPM7064, and EPM7096 devices, the global clock signal is available from a dedicated clock pin, GCLK1, as shown in Figure 1. In MAX 7000E and MAX 7000S devices, two global clock signals are available. As shown in Figure 2, these global clock signals can be the true or the complement of either of the global clock pins, GCLK1 or GCLK2.

Each register also supports asynchronous preset and clear functions. As shown in Figures 3 and 4, the product-term select matrix allocates product terms to control these operations. Although the product-term-driven preset and clear of the register are active high, active-low control can be obtained by inverting the signal within the logic array. In addition, each register clear function can be individually driven by the active-low dedicated global clear pin (GCLRn). Upon power-up, each register in the device will be set to a low state.

All MAX 7000E and MAX 7000S I/O pins have a fast input path to a macrocell register. This dedicated path allows a signal to bypass the PIA and combinatorial logic and be driven to an input D flipflop with an extremely fast (2.5 ns) input setup time.

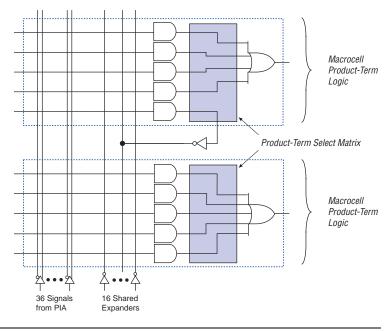
Expander Product Terms

Although most logic functions can be implemented with the five product terms available in each macrocell, the more complex logic functions require additional product terms. Another macrocell can be used to supply the required logic resources; however, the MAX 7000 architecture also allows both shareable and parallel expander product terms ("expanders") that provide additional product terms directly to any macrocell in the same LAB. These expanders help ensure that logic is synthesized with the fewest possible logic resources to obtain the fastest possible speed.

Shareable Expanders

Each LAB has 16 shareable expanders that can be viewed as a pool of uncommitted single product terms (one from each macrocell) with inverted outputs that feed back into the logic array. Each shareable expander can be used and shared by any or all macrocells in the LAB to build complex logic functions. A small delay (t_{SEXP}) is incurred when shareable expanders are used. Figure 5 shows how shareable expanders can feed multiple macrocells.

Figure 5. Shareable Expanders



Shareable expanders can be shared by any or all macrocells in an LAB.

Parallel Expanders

Parallel expanders are unused product terms that can be allocated to a neighboring macrocell to implement fast, complex logic functions. Parallel expanders allow up to 20 product terms to directly feed the macrocell OR logic, with five product terms provided by the macrocell and 15 parallel expanders provided by neighboring macrocells in the LAB. When the tri-state buffer control is connected to ground, the output is tri-stated (high impedance) and the I/O pin can be used as a dedicated input. When the tri-state buffer control is connected to V_{CC} , the output is enabled.

The MAX 7000 architecture provides dual I/O feedback, in which macrocell and pin feedbacks are independent. When an I/O pin is configured as an input, the associated macrocell can be used for buried logic.

In-System Programmability (ISP)

MAX 7000S devices are in-system programmable via an industry-standard 4-pin Joint Test Action Group (JTAG) interface (IEEE Std. 1149.1-1990). ISP allows quick, efficient iterations during design development and debugging cycles. The MAX 7000S architecture internally generates the high programming voltage required to program EEPROM cells, allowing in-system programming with only a single 5.0 V power supply. During in-system programming, the I/O pins are tri-stated and pulled-up to eliminate board conflicts. The pull-up value is nominally 50 k³4.

ISP simplifies the manufacturing flow by allowing devices to be mounted on a printed circuit board with standard in-circuit test equipment before they are programmed. MAX 7000S devices can be programmed by downloading the information via in-circuit testers (ICT), embedded processors, or the Altera MasterBlaster, ByteBlasterMV, ByteBlaster, BitBlaster download cables. (The ByteBlaster cable is obsolete and is replaced by the ByteBlasterMV cable, which can program and configure 2.5-V, 3.3-V, and 5.0-V devices.) Programming the devices after they are placed on the board eliminates lead damage on high-pin-count packages (e.g., QFP packages) due to device handling and allows devices to be reprogrammed after a system has already shipped to the field. For example, product upgrades can be performed in the field via software or modem.

In-system programming can be accomplished with either an adaptive or constant algorithm. An adaptive algorithm reads information from the unit and adapts subsequent programming steps to achieve the fastest possible programming time for that unit. Because some in-circuit testers cannot support an adaptive algorithm, Altera offers devices tested with a constant algorithm. Devices tested to the constant algorithm have an "F" suffix in the ordering code.

The Jam[™] Standard Test and Programming Language (STAPL) can be used to program MAX 7000S devices with in-circuit testers, PCs, or embedded processor.

The programming times described in Tables 6 through 8 are associated

| Device | Progra | mming | Stand-Alone Verification | | | | |
|----------|-------------------------|-----------------------|--------------------------|-----------------------|--|--|--|
| | t _{PPULSE} (s) | Cycle _{PTCK} | t _{VPULSE} (s) | Cycle _{VTCK} | | | |
| EPM7032S | 4.02 | 342,000 | 0.03 | 200,000 | | | |
| EPM7064S | 4.50 | 504,000 | 0.03 | 308,000 | | | |
| EPM7128S | 5.11 | 832,000 | 0.03 | 528,000 | | | |
| EPM7160S | 5.35 | 1,001,000 | 0.03 | 640,000 | | | |
| EPM7192S | 5.71 | 1,192,000 | 0.03 | 764,000 | | | |
| EPM7256S | 6.43 | 1,603,000 | 0.03 | 1,024,000 | | | |

with the worst-case method using the enhanced ISP algorithm.

Tables 7 and 8 show the in-system programming and stand alone verification times for several common test clock frequencies.

| Device | | f _{TCK} | | | | | | | | | | | | |
|----------|--------|------------------|-------|-------|---------|---------|---------|--------|---|--|--|--|--|--|
| | 10 MHz | 5 MHz | 2 MHz | 1 MHz | 500 kHz | 200 kHz | 100 kHz | 50 kHz |] | | | | | |
| EPM7032S | 4.06 | 4.09 | 4.19 | 4.36 | 4.71 | 5.73 | 7.44 | 10.86 | s | | | | | |
| EPM7064S | 4.55 | 4.60 | 4.76 | 5.01 | 5.51 | 7.02 | 9.54 | 14.58 | S | | | | | |
| EPM7128S | 5.19 | 5.27 | 5.52 | 5.94 | 6.77 | 9.27 | 13.43 | 21.75 | S | | | | | |
| EPM7160S | 5.45 | 5.55 | 5.85 | 6.35 | 7.35 | 10.35 | 15.36 | 25.37 | S | | | | | |
| EPM7192S | 5.83 | 5.95 | 6.30 | 6.90 | 8.09 | 11.67 | 17.63 | 29.55 | S | | | | | |
| EPM7256S | 6.59 | 6.75 | 7.23 | 8.03 | 9.64 | 14.45 | 22.46 | 38.49 | S | | | | | |

Table 8. MAX 7000S Stand-Alone Verification Times for Different Test Clock Frequencies

| | 1 | | | | | | | | 1 |
|----------|--------|-------|-------|-------|---------|---------|---------|--------|-------|
| Device | | | | f | тск | | | | Units |
| | 10 MHz | 5 MHz | 2 MHz | 1 MHz | 500 kHz | 200 kHz | 100 kHz | 50 kHz | |
| EPM7032S | 0.05 | 0.07 | 0.13 | 0.23 | 0.43 | 1.03 | 2.03 | 4.03 | S |
| EPM7064S | 0.06 | 0.09 | 0.18 | 0.34 | 0.64 | 1.57 | 3.11 | 6.19 | S |
| EPM7128S | 0.08 | 0.14 | 0.29 | 0.56 | 1.09 | 2.67 | 5.31 | 10.59 | S |
| EPM7160S | 0.09 | 0.16 | 0.35 | 0.67 | 1.31 | 3.23 | 6.43 | 12.83 | S |
| EPM7192S | 0.11 | 0.18 | 0.41 | 0.79 | 1.56 | 3.85 | 7.67 | 15.31 | S |
| EPM7256S | 0.13 | 0.24 | 0.54 | 1.06 | 2.08 | 5.15 | 10.27 | 20.51 | S |

By using an external 5.0-V pull-up resistor, output pins on MAX 7000S devices can be set to meet 5.0-V CMOS input voltages. When V_{CCIO} is 3.3 V, setting the open drain option will turn off the output pull-up transistor, allowing the external pull-up resistor to pull the output high enough to meet 5.0-V CMOS input voltages. When V_{CCIO} is 5.0 V, setting the output drain option is not necessary because the pull-up transistor will already turn off when the pin exceeds approximately 3.8 V, allowing the external pull-up resistor to pull the output high enough to meet 5.0-V CMOS input voltages.

Slew-Rate Control

The output buffer for each MAX 7000E and MAX 7000S I/O pin has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A faster slew rate provides high-speed transitions for high-performance systems. However, these fast transitions may introduce noise transients into the system. A slow slew rate reduces system noise, but adds a nominal delay of 4 to 5 ns. In MAX 7000E devices, when the Turbo Bit is turned off, the slew rate is set for low noise performance. For MAX 7000S devices, each I/O pin has an individual EEPROM bit that controls the slew rate, allowing designers to specify the slew rate on a pin-by-pin basis.

MAX 7000 devices can be programmed on Windows-based PCs with the Altera Logic Programmer card, the Master Programming Unit (MPU), and the appropriate device adapter. The MPU performs a continuity check to ensure adequate electrical contact between the adapter and the device.

For more information, see the *Altera Programming Hardware Data Sheet*.

The Altera development system can use text- or waveform-format test vectors created with the Text Editor or Waveform Editor to test the programmed device. For added design verification, designers can perform functional testing to compare the functional behavior of a MAX 7000 device with the results of simulation. Moreover, Data I/O, BP Microsystems, and other programming hardware manufacturers also provide programming support for Altera devices.



For more information, see the Programming Hardware Manufacturers.

Programming with External Hardware

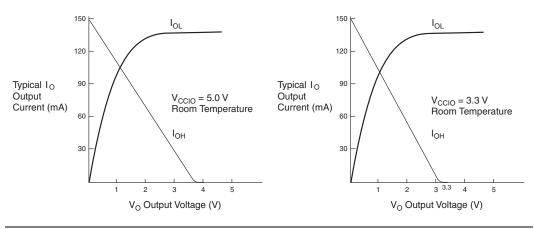
MAX 7000 Programmable Logic Device Family Data Sheet

Notes to tables:

- (1) See the Operating Requirements for Altera Devices Data Sheet.
- (2) Minimum DC input voltage on I/O pins is -0.5 V and on 4 dedicated input pins is -0.3 V. During transitions, the inputs may undershoot to -2.0 V or overshoot to 7.0 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) Numbers in parentheses are for industrial-temperature-range devices.
- (4) V_{CC} must rise monotonically.
- (5) The POR time for all 7000S devices does not exceed 300 μs. The sufficient V_{CCINT} voltage level for POR is 4.5 V. The device is fully initialized within the POR time after V_{CCINT} reaches the sufficient POR voltage level.
- (6) 3.3-V I/O operation is not available for 44-pin packages.
- (7) The V_{CCISP} parameter applies only to MAX 7000S devices.
- (8) During in-system programming, the minimum DC input voltage is -0.3 V.
- (9) These values are specified under the MAX 7000 recommended operating conditions in Table 14 on page 26.
- (10) The parameter is measured with 50% of the outputs each sourcing the specified current. The I_{OH} parameter refers to high-level TTL or CMOS output current.
- (11) The parameter is measured with 50% of the outputs each sinking the specified current. The I_{OL} parameter refers to low-level TTL, PCI, or CMOS output current.
- (12) When the JTAG interface is enabled in MAX 7000S devices, the input leakage current on the JTAG pins is typically -60 μA.
- (13) Capacitance is measured at 25° C and is sample-tested only. The OE1 pin has a maximum capacitance of 20 pF.

Figure 11 shows the typical output drive characteristics of MAX 7000 devices.

Figure 11. Output Drive Characteristics of 5.0-V MAX 7000 Devices



Timing Model

MAX 7000 device timing can be analyzed with the Altera software, with a variety of popular industry-standard EDA simulators and timing analyzers, or with the timing model shown in Figure 12. MAX 7000 devices have fixed internal delays that enable the designer to determine the worst-case timing of any design. The Altera software provides timing simulation, point-to-point delay prediction, and detailed timing analysis for a device-wide performance evaluation.

| Table 2 | 21. MAX 7000 & MAX 7000E Ext | ernal Timing Parame | eters Note | (1) | | | |
|-------------------|--|---------------------|------------|-----------|-------|-----------------------|------|
| Symbol | Parameter | Conditions | | Speed (| Grade | | Unit |
| | | | MAX 700 | 0E (-10P) | | 00 (-10) Doe (-10) | |
| | | | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 10.0 | | 10.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 10.0 | | 10.0 | ns |
| t _{SU} | Global clock setup time | | 7.0 | | 8.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | (2) | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | (2) | 0.5 | | 0.5 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 5.0 | | 5 | ns |
| t _{CH} | Global clock high time | | 4.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 4.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | | 2.0 | | 3.0 | | ns |
| t _{AH} | Array clock hold time | | 3.0 | | 3.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 10.0 | | 10.0 | ns |
| t _{ACH} | Array clock high time | | 4.0 | | 4.0 | | ns |
| t _{ACL} | Array clock low time | | 4.0 | | 4.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 4.0 | | 4.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (4) | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 10.0 | | 10.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (5) | 100.0 | | 100.0 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 10.0 | | 10.0 | ns |
| f _{acnt} | Maximum internal array clock frequency | (5) | 100.0 | | 100.0 | | MHz |
| f _{MAX} | Maximum clock frequency | (6) | 125.0 | | 125.0 | | MHz |

| Table 2 | 23. MAX 7000 & MAX 7000E Ext | ernal Timing Param | eters Note | e (1) | | | |
|-------------------|--|--------------------|------------|-----------|-------|-----------------------|------|
| Symbol | Parameter | Conditions | | Speed | Grade | | Unit |
| | | | MAX 700 | 0E (-12P) | | 00 (-12) Doe (-12) | |
| | | | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 12.0 | | 12.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 12.0 | | 12.0 | ns |
| t _{SU} | Global clock setup time | | 7.0 | | 10.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | (2) | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | (2) | 0.0 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 6.0 | | 6.0 | ns |
| t _{CH} | Global clock high time | | 4.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 4.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | | 3.0 | | 4.0 | | ns |
| t _{AH} | Array clock hold time | | 4.0 | | 4.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 12.0 | | 12.0 | ns |
| t _{ACH} | Array clock high time | | 5.0 | | 5.0 | | ns |
| t _{ACL} | Array clock low time | | 5.0 | | 5.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 5.0 | | 5.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (4) | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 11.0 | | 11.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (5) | 90.9 | | 90.9 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 11.0 | | 11.0 | ns |
| f _{acnt} | Maximum internal array clock frequency | (5) | 90.9 | | 90.9 | | MHz |
| f _{MAX} | Maximum clock frequency | (6) | 125.0 | | 125.0 | | MHz |

| Symbol | Parameter | Conditions | | Speed | Grade | | Unit |
|-------------------|---|----------------|---------|-----------|-------|-----------------------|------|
| | | | MAX 700 | OE (-12P) | | 00 (-12) DOE (-12) | |
| | | | Min | Max | Min | Max | |
| t _{IN} | Input pad and buffer delay | | | 1.0 | | 2.0 | ns |
| t _{IO} | I/O input pad and buffer delay | | | 1.0 | | 2.0 | ns |
| t _{FIN} | Fast input delay | (2) | | 1.0 | | 1.0 | ns |
| t _{SEXP} | Shared expander delay | | | 7.0 | | 7.0 | ns |
| t _{PEXP} | Parallel expander delay | | | 1.0 | | 1.0 | ns |
| t _{LAD} | Logic array delay | | | 7.0 | | 5.0 | ns |
| t _{LAC} | Logic control array delay | | | 5.0 | | 5.0 | ns |
| t _{IOE} | Internal output enable delay | (2) | | 2.0 | | 2.0 | ns |
| t _{OD1} | Output buffer and pad delay Slow slew rate = off $V_{CCIO} = 5.0 V$ | C1 = 35 pF | | 1.0 | | 3.0 | ns |
| t _{OD2} | Output buffer and pad delay Slow slew rate = off $V_{CCIO} = 3.3 V$ | C1 = 35 pF (7) | | 2.0 | | 4.0 | ns |
| t _{OD3} | Output buffer and pad delay Slow slew rate = on V _{CCIO} = 5.0 V or 3.3 V | C1 = 35 pF (2) | | 5.0 | | 7.0 | ns |
| t _{ZX1} | Output buffer enable delay Slow slew rate = off $V_{CCIO} = 5.0 V$ | C1 = 35 pF | | 6.0 | | 6.0 | ns |
| t _{ZX2} | Output buffer enable delay Slow slew rate = off $V_{CCIO} = 3.3 V$ | C1 = 35 pF (7) | | 7.0 | | 7.0 | ns |
| t _{ZX3} | Output buffer enable delay Slow slew rate = on $V_{CCIO} = 5.0 V \text{ or } 3.3 V$ | C1 = 35 pF (2) | | 10.0 | | 10.0 | ns |
| t _{XZ} | Output buffer disable delay | C1 = 5 pF | | 6.0 | | 6.0 | ns |
| t _{SU} | Register setup time | | 1.0 | | 4.0 | | ns |
| t _H | Register hold time | | 6.0 | | 4.0 | | ns |
| t _{FSU} | Register setup time of fast input | (2) | 4.0 | | 2.0 | | ns |
| t _{FH} | Register hold time of fast input | (2) | 0.0 | | 2.0 | | ns |
| t _{RD} | Register delay | | | 2.0 | | 1.0 | ns |
| t _{COMB} | Combinatorial delay | | | 2.0 | | 1.0 | ns |
| t _{IC} | Array clock delay | | | 5.0 | | 5.0 | ns |
| t _{EN} | Register enable time | | | 7.0 | | 5.0 | ns |
| t _{GLOB} | Global control delay | | | 2.0 | | 0.0 | ns |
| t _{PRE} | Register preset time | | | 4.0 | | 3.0 | ns |
| t _{CLR} | Register clear time | | | 4.0 | | 3.0 | ns |
| t _{PIA} | PIA delay | | | 1.0 | | 1.0 | ns |
| t _{LPA} | Low-power adder | (8) | | 12.0 | | 12.0 | ns |

Notes to tables:

- (1) These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
- (2) This parameter applies to MAX 7000E devices only.
- (3) This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (4) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (5) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (6) The f_{MAX} values represent the highest frequency for pipelined data.
- (7) Operating conditions: $V_{CCIO} = 3.3 \text{ V} \pm 10\%$ for commercial and industrial use.
- (8) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , t_{ACL} , and t_{CPPW} parameters for macrocells running in the low-power mode.

Tables 27 and 28 show the EPM7032S AC operating conditions.

| Symbol | Parameter | Conditions | | | | Speed | Grade | | | | Unit |
|-------------------|---|----------------|-------|-----|-------|-------|-------|-----|-------|------|------|
| | | | - | 5 | - | 6 | - | 7 | -1 | 0 | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 5.0 | | 6.0 | | 7.5 | | 10.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 5.0 | | 6.0 | | 7.5 | | 10.0 | ns |
| t _{SU} | Global clock setup time | | 2.9 | | 4.0 | | 5.0 | | 7.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | | 2.5 | | 2.5 | | 2.5 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.0 | | 0.0 | | 0.5 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 3.2 | | 3.5 | | 4.3 | | 5.0 | ns |
| t _{CH} | Global clock high time | | 2.0 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 2.0 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | | 0.7 | | 0.9 | | 1.1 | | 2.0 | | ns |
| t _{AH} | Array clock hold time | | 1.8 | | 2.1 | | 2.7 | | 3.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 5.4 | | 6.6 | | 8.2 | | 10.0 | ns |
| t _{ACH} | Array clock high time | | 2.5 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{ACL} | Array clock low time | | 2.5 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (2) | 2.5 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{odh} | Output data hold time after clock | C1 = 35 pF (3) | 1.0 | | 1.0 | | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 5.7 | | 7.0 | | 8.6 | | 10.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (4) | 175.4 | | 142.9 | | 116.3 | | 100.0 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 5.7 | | 7.0 | | 8.6 | | 10.0 | ns |

| Table 2 | 8. EPM7032S Internal T | iming Parameter | rs A | lote (1) | | | | | | | |
|------------------|------------------------|-----------------|------|---------------------------------|---|-------|-------|------|----|------|------|
| Symbol | Parameter | Conditions | | | | Speed | Grade | | | | Unit |
| | | | - | 5 | - | 6 | - | 7 | -1 | 0 | |
| | | | Min | Min Max Min Max Min Max Min Max | | | | | | | |
| t _{PIA} | PIA delay | (7) | | 1.1 | | 1.1 | | 1.4 | | 1.0 | ns |
| t _{LPA} | Low-power adder | (8) | | 12.0 | | 10.0 | | 10.0 | | 11.0 | ns |

Notes to tables:

- (1) These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
- (2) This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (3) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (4) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) The f_{MAX} values represent the highest frequency for pipelined data.
- (6) Operating conditions: $V_{CCIO} = 3.3 \text{ V} \pm 10\%$ for commercial and industrial use.
- (7) For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (8) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , t_{ACL} , and t_{CPPW} parameters for macrocells running in the low-power mode.

Tables 29 and 30 show the EPM7064S AC operating conditions.

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | | |
|------------------|---------------------------------------|------------|-------------|-----|-----|-----|-----|-----|-----|------|----|--|
| | | | -5 | | -6 | | -7 | | -10 | | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 5.0 | | 6.0 | | 7.5 | | 10.0 | ns | |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 5.0 | | 6.0 | | 7.5 | | 10.0 | ns | |
| t _{SU} | Global clock setup time | | 2.9 | | 3.6 | | 6.0 | | 7.0 | | ns | |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | 0.0 | | 0.0 | | ns | |
| t _{FSU} | Global clock setup time of fast input | | 2.5 | | 2.5 | | 3.0 | | 3.0 | | ns | |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.0 | | 0.5 | | 0.5 | | ns | |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 3.2 | | 4.0 | | 4.5 | | 5.0 | ns | |
| t _{CH} | Global clock high time | | 2.0 | | 2.5 | | 3.0 | | 4.0 | | ns | |
| t _{CL} | Global clock low time | | 2.0 | | 2.5 | | 3.0 | | 4.0 | | ns | |
| t _{ASU} | Array clock setup time | | 0.7 | | 0.9 | | 3.0 | | 2.0 | | ns | |
| t _{AH} | Array clock hold time | | 1.8 | | 2.1 | | 2.0 | | 3.0 | | ns | |

| Symbol | Parameter | Conditions | | | | Speed | Grade | | | | Unit |
|-------------------|-----------------------------------|----------------|-----|------|-----|-------|-------|------|-----|------|------|
| | | | -6 | | -7 | | -10 | | -15 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | - |
| t _{IN} | Input pad and buffer delay | | | 0.2 | | 0.5 | | 0.5 | | 2.0 | ns |
| t _{IO} | I/O input pad and buffer delay | | | 0.2 | | 0.5 | | 0.5 | | 2.0 | ns |
| t _{FIN} | Fast input delay | | | 2.6 | | 1.0 | | 1.0 | | 2.0 | ns |
| t _{SEXP} | Shared expander delay | | | 3.7 | | 4.0 | | 5.0 | | 8.0 | ns |
| t _{PEXP} | Parallel expander delay | | | 1.1 | | 0.8 | | 0.8 | | 1.0 | ns |
| t _{LAD} | Logic array delay | | | 3.0 | | 3.0 | | 5.0 | | 6.0 | ns |
| t _{LAC} | Logic control array delay | | | 3.0 | | 3.0 | | 5.0 | | 6.0 | ns |
| t _{IOE} | Internal output enable delay | | | 0.7 | | 2.0 | | 2.0 | | 3.0 | ns |
| t _{OD1} | Output buffer and pad delay | C1 = 35 pF | | 0.4 | | 2.0 | | 1.5 | | 4.0 | ns |
| t _{OD2} | Output buffer and pad delay | C1 = 35 pF (6) | | 0.9 | | 2.5 | | 2.0 | | 5.0 | ns |
| t _{OD3} | Output buffer and pad delay | C1 = 35 pF | | 5.4 | | 7.0 | | 5.5 | | 8.0 | ns |
| t _{ZX1} | Output buffer enable delay | C1 = 35 pF | | 4.0 | | 4.0 | | 5.0 | | 6.0 | ns |
| t _{ZX2} | Output buffer enable delay | C1 = 35 pF (6) | | 4.5 | | 4.5 | | 5.5 | | 7.0 | ns |
| t _{ZX3} | Output buffer enable delay | C1 = 35 pF | | 9.0 | | 9.0 | | 9.0 | | 10.0 | ns |
| t _{XZ} | Output buffer disable delay | C1 = 5 pF | | 4.0 | | 4.0 | | 5.0 | | 6.0 | ns |
| t _{SU} | Register setup time | | 1.0 | | 3.0 | | 2.0 | | 4.0 | | ns |
| t _H | Register hold time | | 1.7 | | 2.0 | | 5.0 | | 4.0 | | ns |
| t _{FSU} | Register setup time of fast input | | 1.9 | | 3.0 | | 3.0 | | 2.0 | | ns |
| t _{FH} | Register hold time of fast input | | 0.6 | | 0.5 | | 0.5 | | 1.0 | | ns |
| t _{RD} | Register delay | | | 1.4 | | 1.0 | | 2.0 | | 1.0 | ns |
| t _{COMB} | Combinatorial delay | | | 1.0 | | 1.0 | | 2.0 | | 1.0 | ns |
| t _{IC} | Array clock delay | | | 3.1 | | 3.0 | | 5.0 | | 6.0 | ns |
| t _{EN} | Register enable time | | | 3.0 | | 3.0 | | 5.0 | | 6.0 | ns |
| t _{GLOB} | Global control delay | | | 2.0 | | 1.0 | | 1.0 | | 1.0 | ns |
| t _{PRE} | Register preset time | | | 2.4 | | 2.0 | | 3.0 | | 4.0 | ns |
| t _{CLR} | Register clear time | | | 2.4 | | 2.0 | | 3.0 | | 4.0 | ns |
| t _{PIA} | PIA delay | (7) | | 1.4 | | 1.0 | | 1.0 | | 2.0 | ns |
| t _{LPA} | Low-power adder | (8) | | 11.0 | | 10.0 | | 11.0 | | 13.0 | ns |

Notes to tables:

- (1) These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
- (2) This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (3) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (4) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) The f_{MAX} values represent the highest frequency for pipelined data.
- (6) Operating conditions: $V_{CCIO} = 3.3 \text{ V} \pm 10\%$ for commercial and industrial use.
- (7) For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (8) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , t_{ACL} , and t_{CPPW} parameters for macrocells running in the low-power mode.

Tables 33 and 34 show the EPM7160S AC operating conditions.

| Symbol | Parameter | Conditions | | | | Speed | Grade |) | | | Unit |
|-------------------|---|-----------------------|-------|-----|-------|-------|-------|------|------|------|------|
| | | | -6 | | -7 | | -10 | | -15 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 6.0 | | 7.5 | | 10.0 | | 15.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 6.0 | | 7.5 | | 10.0 | | 15.0 | ns |
| t _{SU} | Global clock setup time | | 3.4 | | 4.2 | | 7.0 | | 11.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | | 2.5 | | 3.0 | | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.0 | | 0.5 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 3.9 | | 4.8 | | 5 | | 8 | ns |
| t _{CH} | Global clock high time | | 3.0 | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{CL} | Global clock low time | | 3.0 | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{ASU} | Array clock setup time | | 0.9 | | 1.1 | | 2.0 | | 4.0 | | ns |
| t _{AH} | Array clock hold time | | 1.7 | | 2.1 | | 3.0 | | 4.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 6.4 | | 7.9 | | 10.0 | | 15.0 | ns |
| t _{ACH} | Array clock high time | | 3.0 | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{ACL} | Array clock low time | | 3.0 | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (2) | 2.5 | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF <i>(3)</i> | 1.0 | | 1.0 | | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 6.7 | | 8.2 | | 10.0 | | 13.0 | ns |
| f _{сnт} | Maximum internal global clock frequency | (4) | 149.3 | | 122.0 | | 100.0 | | 76.9 | | MHz |

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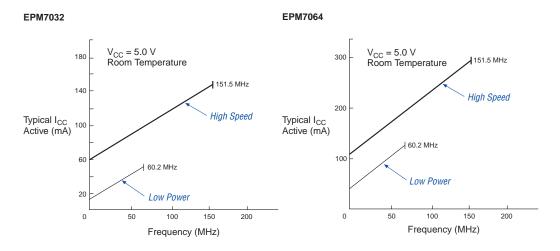
| Symbol | Parameter | Conditions | Speed Grade | | | | | | |
|-------------------|---|----------------|-------------|-----|-------|------|-------|------|-----|
| | | | -7 | | -10 | | -15 | | _ |
| | | | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 7.5 | | 10.0 | | 15.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 7.5 | | 10.0 | | 15.0 | ns |
| t _{SU} | Global clock setup time | | 3.9 | | 7.0 | | 11.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | | 3.0 | | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.5 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 4.7 | | 5.0 | | 8.0 | ns |
| t _{CH} | Global clock high time | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{CL} | Global clock low time | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{ASU} | Array clock setup time | | 0.8 | | 2.0 | | 4.0 | | ns |
| t _{AH} | Array clock hold time | | 1.9 | | 3.0 | | 4.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 7.8 | | 10.0 | | 15.0 | ns |
| t _{ACH} | Array clock high time | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{ACL} | Array clock low time | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (2) | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (3) | 1.0 | | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 7.8 | | 10.0 | | 13.0 | ns |
| fcnt | Maximum internal global clock frequency | (4) | 128.2 | | 100.0 | | 76.9 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 7.8 | | 10.0 | | 13.0 | ns |
| f _{acnt} | Maximum internal array clock frequency | (4) | 128.2 | | 100.0 | | 76.9 | | MHz |
| f _{MAX} | Maximum clock frequency | (5) | 166.7 | | 125.0 | | 100.0 | | MHz |

Tables 37 and 38 show the EPM7256S AC operating conditions.

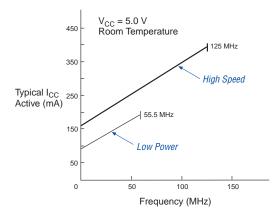
| Table 39. MAX 7000 I _{CC} Equation Constants | | | | | | | | |
|---|------|------|-------|--|--|--|--|--|
| Device | A | В | C | | | | | |
| EPM7032 | 1.87 | 0.52 | 0.144 | | | | | |
| EPM7064 | 1.63 | 0.74 | 0.144 | | | | | |
| EPM7096 | 1.63 | 0.74 | 0.144 | | | | | |
| EPM7128E | 1.17 | 0.54 | 0.096 | | | | | |
| EPM7160E | 1.17 | 0.54 | 0.096 | | | | | |
| EPM7192E | 1.17 | 0.54 | 0.096 | | | | | |
| EPM7256E | 1.17 | 0.54 | 0.096 | | | | | |
| EPM7032S | 0.93 | 0.40 | 0.040 | | | | | |
| EPM7064S | 0.93 | 0.40 | 0.040 | | | | | |
| EPM7128S | 0.93 | 0.40 | 0.040 | | | | | |
| EPM7160S | 0.93 | 0.40 | 0.040 | | | | | |
| EPM7192S | 0.93 | 0.40 | 0.040 | | | | | |
| EPM7256S | 0.93 | 0.40 | 0.040 | | | | | |

This calculation provides an I_{CC} estimate based on typical conditions using a pattern of a 16-bit, loadable, enabled, up/down counter in each LAB with no output load. Actual I_{CC} values should be verified during operation because this measurement is sensitive to the actual pattern in the device and the environmental operating conditions. Figure 14 shows typical supply current versus frequency for MAX 7000 devices.





EPM7096



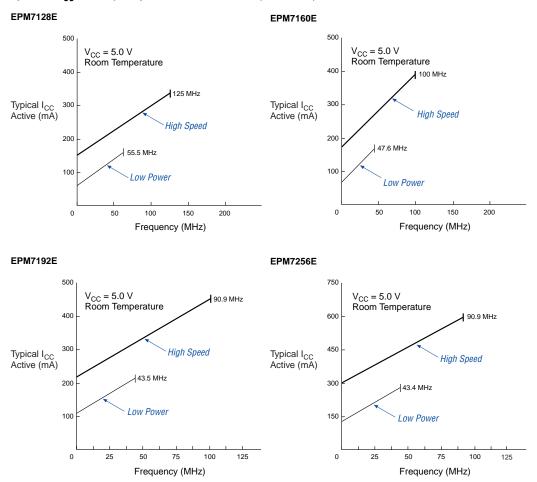


Figure 14. I_{CC} vs. Frequency for MAX 7000 Devices (Part 2 of 2)